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2826

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Grigg et al.

Serial No.: 10/035,078

Filed: December 28, 2001

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Examiner: Unknown

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Attorney Docket No.: 3134.7US (96-1171.7)

PATENT

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CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

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Signature of registered practitioner or other person having reasonable basis to expect mailing to occur on day of deposit shown pursuant to 37 C.F.R. § 1.8(a)(1)(ii)

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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the document listed on attached Form PTO-1449 be considered by the Examiner and made of record. The listed document is from co-pending application Serial No. 10/067,592, filed February 4, 2002. A copy of the listed document is enclosed pursuant to 37 C.F.R. § 1.98(a).

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as

Serial No. 10/035,078

defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56(b) exists.

DOCUMENTS

U.S. Patent Documents

<u>U.S. Patent No.</u>	<u>Issue Date</u>	<u>Inventor</u>
5,982,041	11/1999	Mitani et al.

Applicants offer to supply any explanation or discussion of the document which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed before the mailing date of a first Office Action on the merits.

Respectfully submitted,



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Date: June 27, 2002

JRD/sls:djp

Enclosures: Form PTO-1449  
Copy of documents cited